

# 國立中央大學九十一年度碩士班研究生入學試題卷

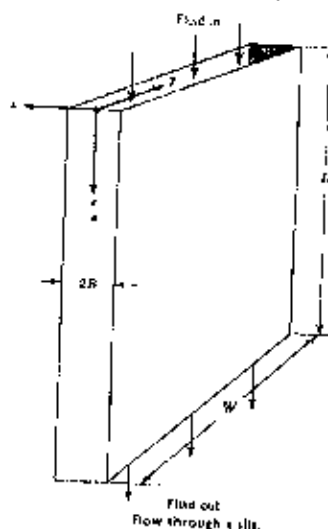
所別：化學工程與材料工程學系 科目：輸送現象與單元操作 共 2 頁 第 1 頁  
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## 1. (25%) Laminar Flow in a Narrow Slit

A viscous fluid is in laminar flow in a slit formed by two parallel walls a distance  $2B$  apart. (a) Obtain the velocity distribution  $v_x(x)$  by solving the N-S equation. (10%) (b) Obtain the expression for the distribution of momentum flux. (10%) (c) What is the ratio of average to maximum velocity in the slit? (5%)

Hint: z-momentum:

$$\rho(v_x \partial v_x / \partial x + v_y \partial v_x / \partial y + v_z \partial v_x / \partial z) = -\partial p / \partial z + \mu(\partial^2 v_x / \partial x^2 + \partial^2 v_x / \partial y^2 + \partial^2 v_x / \partial z^2) + \rho g_x$$



## 2. (10%) Determination of Viscosity ( $\mu$ ) from Terminal Velocity ( $v_t$ ) of a Falling Sphere (radius R)

Derive a relation that enables one to get the viscosity of a fluid by measuring the steady-state rate of fall of a sphere in the fluid. What is the range of applicability of Stokes law?

3. (15%) A steel tube ( $k=50 \text{ W/m K}$ ) of inner and outer diameter  $D_i = 20 \text{ mm}$  and  $D_o = 26 \text{ mm}$ , respectively, is used to transfer heat from hot gases flowing over the tube ( $h_o = 200 \text{ W/m}^2 \cdot \text{K}$ ) to cold water flowing through the tube ( $h_i = 8000 \text{ W/m}^2 \cdot \text{K}$ ).

For radial conduction in a cylindrical wall, the heat transfer rate is  $q = 2\pi Lk(T_o - T_i) / \ln(D_o / D_i)$ .

(a) What is the conduction resistance of the tube wall? (5%)

(b) What is the cold side overall heat transfer coefficient  $U_c$ ? (10%)

參考用

注意：背面有試題

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4. (20%) Forced air at  $25^{\circ}\text{C}$  and  $10\text{ m/s}$  is used to cool electronic elements mounted on a circuit board. Consider a chip of length  $4\text{ mm}$  and width  $4\text{ mm}$  located  $120\text{ mm}$  from the leading edge. Because the board surface is irregular, the flow is disturbed

and the appropriate convection correlation is of the form  $Nu_x = 0.04 Re_x^{0.9} Pr^{1/3}$ .

Estimate the surface temperature of the chip, if the heat dissipation rate is  $30\text{ mW}$ .

The properties of air (at  $310\text{ K}$ ):

$$k = 27.0 \times 10^{-3} \text{ W/m}\cdot\text{K}, \nu = 16.9 \times 10^{-6} \text{ m}^2/\text{s}, \alpha = 24.0 \times 10^{-6} \text{ m}^2/\text{s}$$

5. (15%) The slow reaction  $A \rightarrow B + 2C$  takes place on the surface of a flat catalyst.

The reaction is first order in A. Obtain (a) the concentration profile of A in the film surrounding the surface and (b) an expression for the flux of A at  $Z=\delta$ .

6. (15%) The theoretical models for mass transfer at a fluid-fluid interface are film theory, penetration theory, surface renewal theory and etc....., please select one of the model and modify the model as there is reaction (interaction) between solutes.